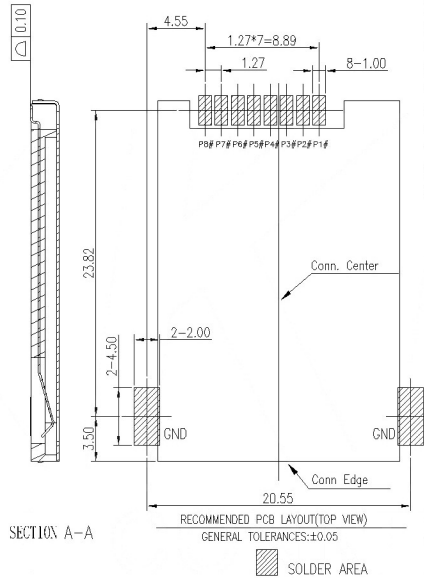
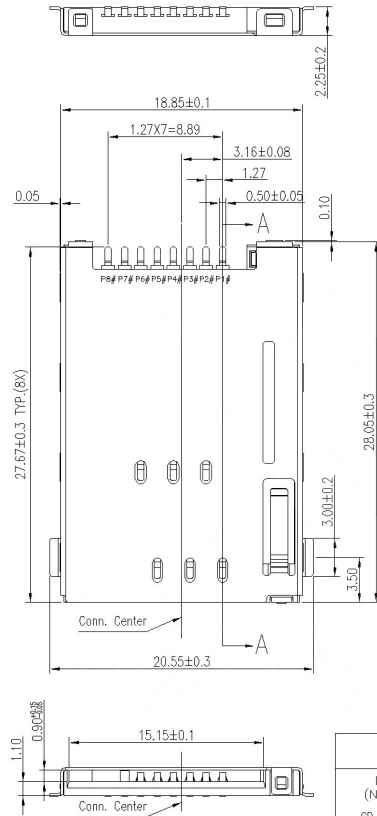


Specification

* Electrical Characteristics :
Current Rating: 0.5A AC/DC Max.
Dielectric Withstanding Voltage: 250V AC/DC
Insulation Resistance: 500M ohms Min.
Contact Resistance: 100m ohms Max.

* Mechanical Characteristics:

Mating Cycles: 5000 Insertions.

* Environmental :

Operating Temperature: -40°C to +85°C.

* Material:

1. Housing: HI-Temp plastic UL 94V-0 Rated.

2. Contact: Copper Alloy.

3. Shell: Stainless Steel, t=0.20mm.

* Plating :

Terminal:

Contact area: G/F Plated Over Nickel.

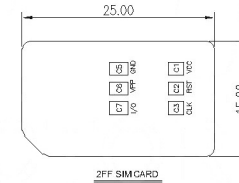
Solder area: Tin Plated Over Nickel.

Under plate: Nickel.

Shell:

Nickel Plated Over All,

Solder Area: Gold Flash.



PIN NO.	DESCRIPTION
P1#	C1:VCC
P2#	C5:GND
P3#	C2:RST
P4#	C6:VPP
P5#	C3:CLK
P6#	C7:I/O
P7#	CD SW LOWER
P8#	CD SW UPPER

③	Shell	1	SUS	
②	Terminal	8	COPPER ALLOY	
①	Housing	1	HI-TEMP. PLASIC UL 94V-0	BLACK
ITEM	PAPT NAME	QTY	MATERIAL	FINISHING

						ANGLAR	±5°	DSND		DATE		SCALE: N/A	MODEL TYPE: SIM CARD CONN		
△ X						L ≤ 4	±0.2	DWN		DATE		VIEW: 	PART NO.:		
△ X						4 < L ≤ 16	±0.3	CHKD		DATE		UNIT: mm	DWG NO.:		
△ X						16 < L ≤ 63	±0.4	APPD		DATE		SIZE: A4	XKSIM-010		
MARK	DESCRIPTION	DATE	REVISED	APPROVED		L > 63	±0.5								
REVISIONS							UNSPECIFIED TOLERANCES	KOSOD TECHNOLOGY CO., LTD					WEIGHT	SHEET	REVISION
www.bodongkaiguan.net www.ksdkg.com													1.0g	1/1	A0